Master Programme in Embedded Electronics Engineering

Programme code: TAEEE
Scope: 120 credits
Cycle: Second
Approved by: Programme Board E
Validity: 2019/2020
Date of approval: 25 March 2019
In addition to the syllabus, general regulations and information for the Faculty of Engineering apply to this programme.

1 Aim and outcomes

1.1 Aim
This internationally oriented Master's programme aims to develop the students' knowledge, skills and judgement in the area of embedded electronics engineering. It is motivated by the dramatic changes taking place in the Application Specific Integrated Circuit (ASIC) and IC fields.

In circuit design an engineer implements function, either whole systems or functions that in turn build up more complex systems. Functions that are implemented are e.g., processor cores, transceivers, data converters, sensors, accelerators or other electronic components. System on chip integrates several function blocks and thus reaches high complexity. System on chip is used in a diverse field of applications such as; e-Health, telecommunication, automotive industry etc.

Embedded systems often use one or more system on chip that are based in dialogue with different audiences, and constitute the field of embedded electronics engineering/system on chip, with previous knowledge, new knowledge in the field of electronics and integrate this knowledge and different types of project work, including background material, investigation and findings, to expert and non-expert audiences in international contexts.

1.2 Outcomes for a Degree of Master of Science (120 credits)
(Higher Education Ordinance 1993:100)

Knowledge and understanding
For a Degree of Master of Science (120 credits) the student shall
- demonstrate knowledge and understanding in the main field of study, including both broad knowledge of the field and a considerable degree of specialised knowledge in certain areas of the field as well as insight into current research and development work, and
- demonstrate specialised methodological knowledge in the main field of study.

Competence and skills
For a Degree of Master of Science (120 credits) the student shall
- demonstrate the ability to critically and systematically integrate knowledge and analyse, assess and deal with complex phenomena, issues and situations even with limited information,
- demonstrate the ability to identify and formulate issues critically, autonomously and creatively as well as to plan and, using appropriate methods, undertake advanced tasks within predetermined time frames and so contribute to the formation of knowledge as well as the ability to evaluate this work,
- demonstrate the ability to develop and design electronic systems or parts embedded electronics engineering/system on chip,
- demonstrate the ability to critically and systematically acquire new knowledge in the field of electronics and integrate this with previous knowledge,
- demonstrate the ability to design, simulate and evaluate systems or parts embedded electronics engineering/system on chip,
- demonstrate the ability to autonomously plan and complete advanced tasks,
- demonstrate the ability to develop and design electronic systems and their constituents while taking into account the circumstances and needs of individuals and the targets for sustainable development set by the community, and
- demonstrate the ability to report in speech and writing their knowledge and different types of project work, including background material, investigation and findings, to expert and non-expert audiences in international contexts.

1.3 Specific outcomes for a Degree of Master of Science (120 credits)

Knowledge and understanding
For a Degree of Master of Science (120 credits) students shall
- demonstrate specialised knowledge of the foundations in electronics and computer science to the sub-fields relevant to the field of embedded electronics engineering/system on chip,
- understand how different domains interact, such as hardware versus software and analogue versus digital construction, and
- demonstrate knowledge of intellectual property rights in general and of the field of embedded electronics engineering/system on chip in particular.

Competence and skills
For a Degree of Master of Science (120 credits) students shall
- demonstrate the ability to identify, formulate and deal with complex issues in the field of embedded electronics engineering/system on chip critically, autonomously and creatively and with a holistic approach,
- analyse and critically evaluate different technical solutions,
- demonstrate the ability to participate in research and development projects,
- demonstrate the ability to critically and systematically acquire new knowledge in the field of electronics and integrate this with previous knowledge,
- demonstrate the ability to design, simulate and evaluate systems or parts embedded electronics engineering/system on chip,
- demonstrate the ability to autonomously plan and complete advanced tasks,
- demonstrate the ability to develop and design electronic systems and their constituents while taking into account the circumstances and needs of individuals and the targets for sustainable development set by the community, and
- demonstrate the ability to report in speech and writing their knowledge and different types of project work, including background material, investigation and findings, to expert and non-expert audiences in international contexts.
Judgement and approach
For a Degree of Master of Science (120 credits) students shall
- demonstrate the ability to make assessments informed by relevant disciplinary, social and ethical aspects,
- demonstrate the capacity for teamwork and collaboration with various constellations, and
- demonstrate the ability to identify their need for further knowledge in the field and to continuously upgrade and broaden their knowledge.

1.4 Further studies
On completion of the second-cycle degree, students have basic eligibility for third-cycle studies.

2 Programme structure
The programme includes a compulsory block of courses intended to provide an orientation in modern chip design. The aim is to provide a general overview of embedded electronics engineering and a foundation for an understanding of all types of IC design, i.e. in digital, mixed signal and analogue design, and also basic knowledge of built-in systems. Students may be allowed to attend PhD courses that fit into the master’s programme.

2.1 Courses
The courses included in the programme are indicated in the timetable. Students are entitled to accreditation of 7.5 credits of courses in Swedish (organised by Lund University for exchange students).

3 Specific admission requirements

3.1 Admission requirements
A Bachelor’s degree in electrical engineering, computer science or equivalent including. Completed courses in mathematics (calculus, differential equations, transform theory and linear algebra) of at least 30 credits/ECTS, as well as completed courses in basic circuit theory, electronics, analogue electronics and digital electronics corresponding at least 30 credits/ECTS in total. The applicant must have basic programming skills (at least on course) and knowledge of electronic description languages, such as VHDL/Verilog. English 6.

4 Degree

4.1 Degree requirements
For a Degree of Master of Science (120 credits) students must successfully complete courses comprising 120 credits, including a degree project worth 30 credits. 75 credits must be second-cycle credits, including the degree project.

4.1.1 Degree project
The degree projects included in the programme are listed in the timetable.

4.2 Degree and degree certificate
When students have completed all the degree requirements, they are entitled to apply for a degree certificate for a Master of Science (120 credits). Main Field of Study: Electronic Design.